

High Resolution XPS study of oxide layers grown on Ge substrates using synchrotron radiation

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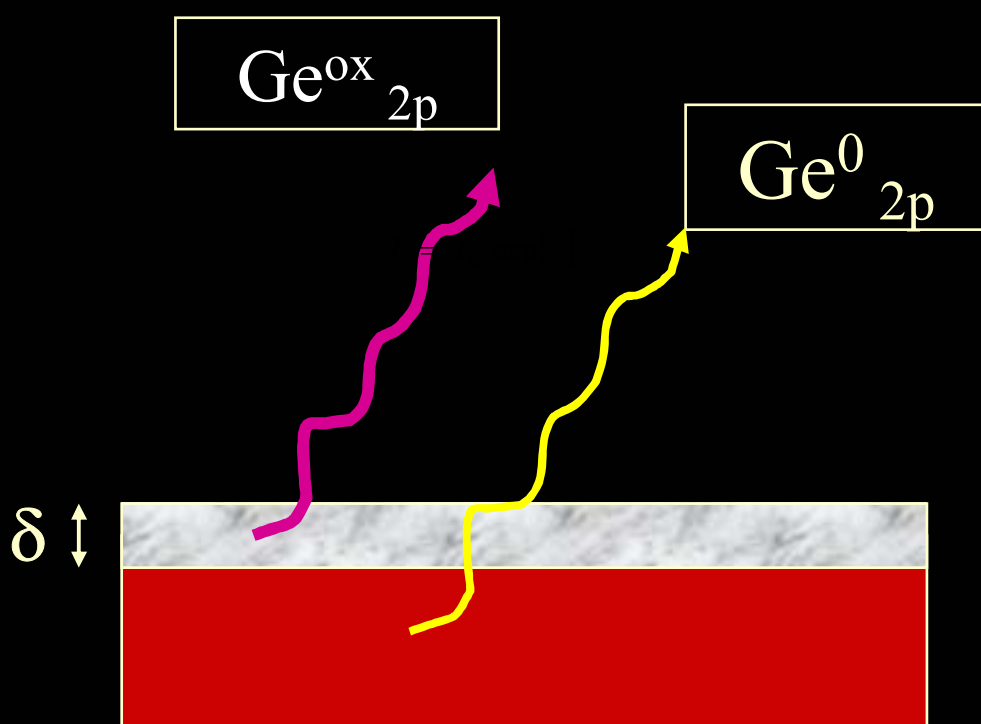
Outline

1. Conventional XPS monitoring of the oxide growth

2. High resolution XPS analysis

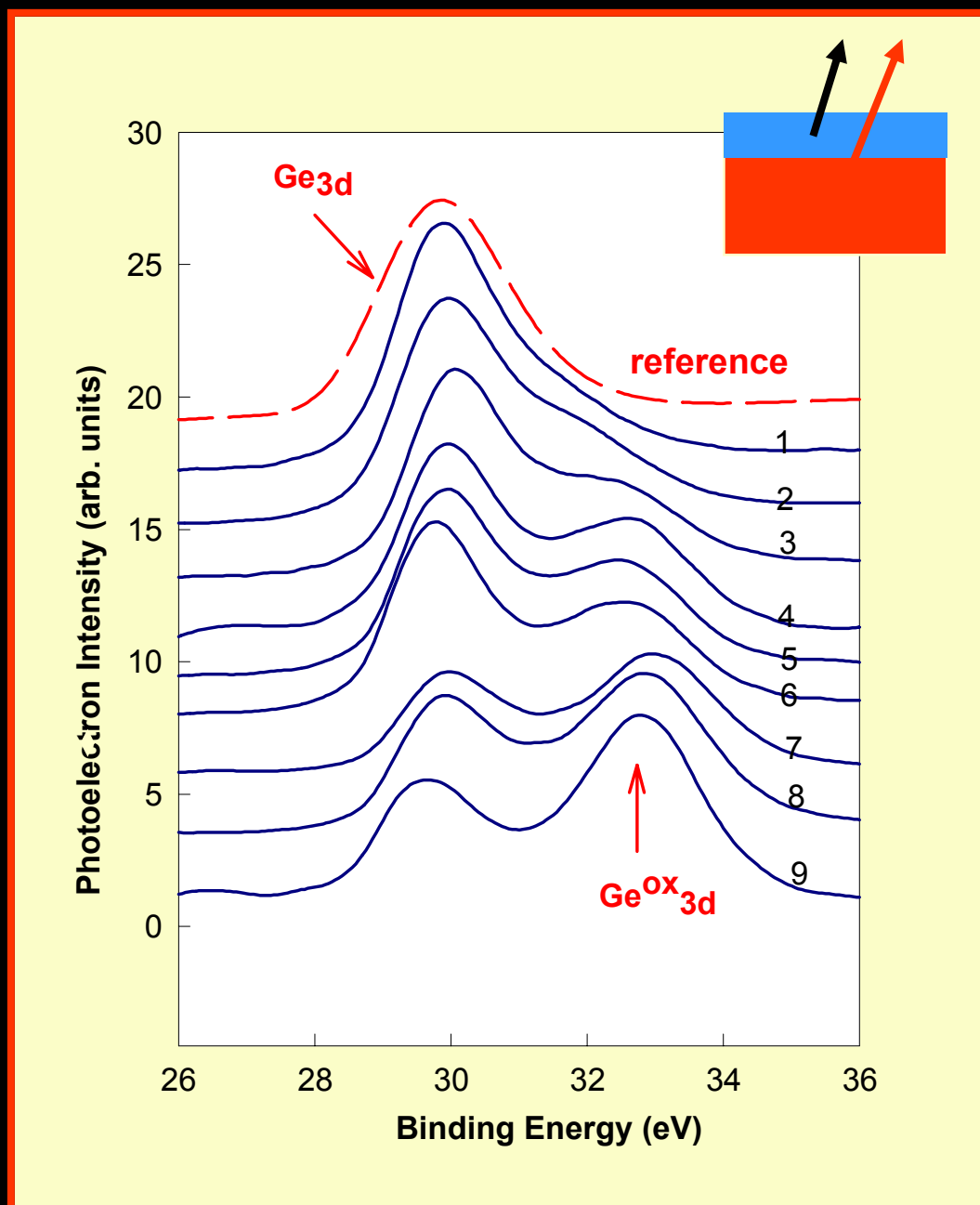
- **Native Oxide**
- **Oxide layers obtained by dry oxidation**

XPS Monitoring of the Oxide growth



$$I = I_0 \exp - \left[\frac{\delta}{\lambda \sin \theta} \right]$$
$$\lambda (\text{Ge } 2p) = 5.3 \text{ ML}$$

Conventional XPS analysis



N. Tabet et al. 2001

XPS at ALS – Berkeley (Synchrotron radiation)



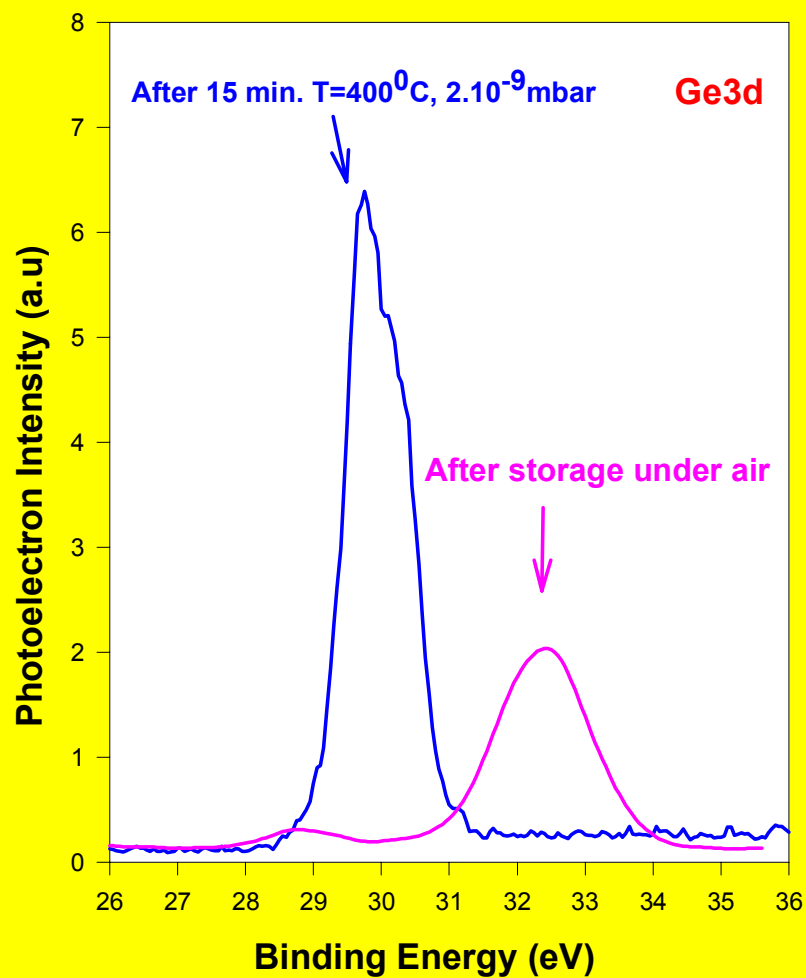
Beam line 9.3.2

$h\nu = 300-700 \text{ eV}$

Energy Resolution: $E/\Delta E \sim 10000$

High Resolution XPS using Synchrotron radiation

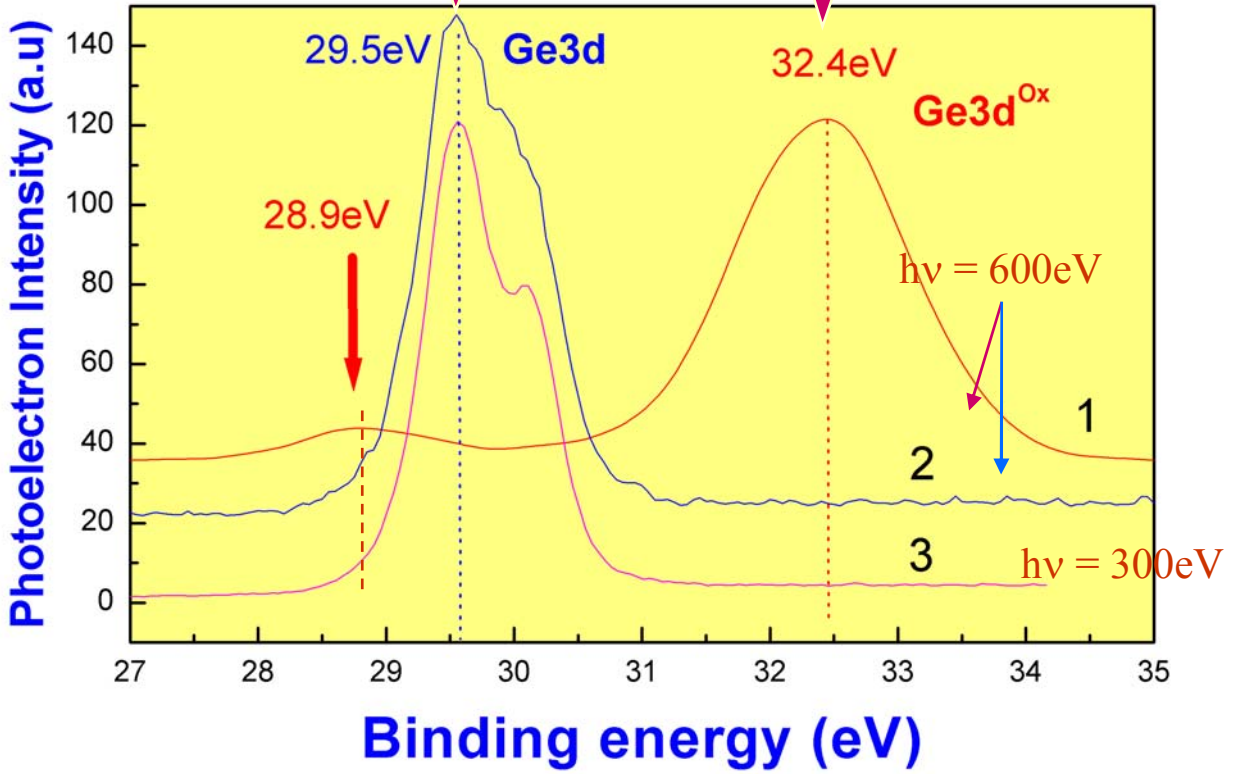
ALS- Berkeley, 2000



Native oxide on CP4 etched surface

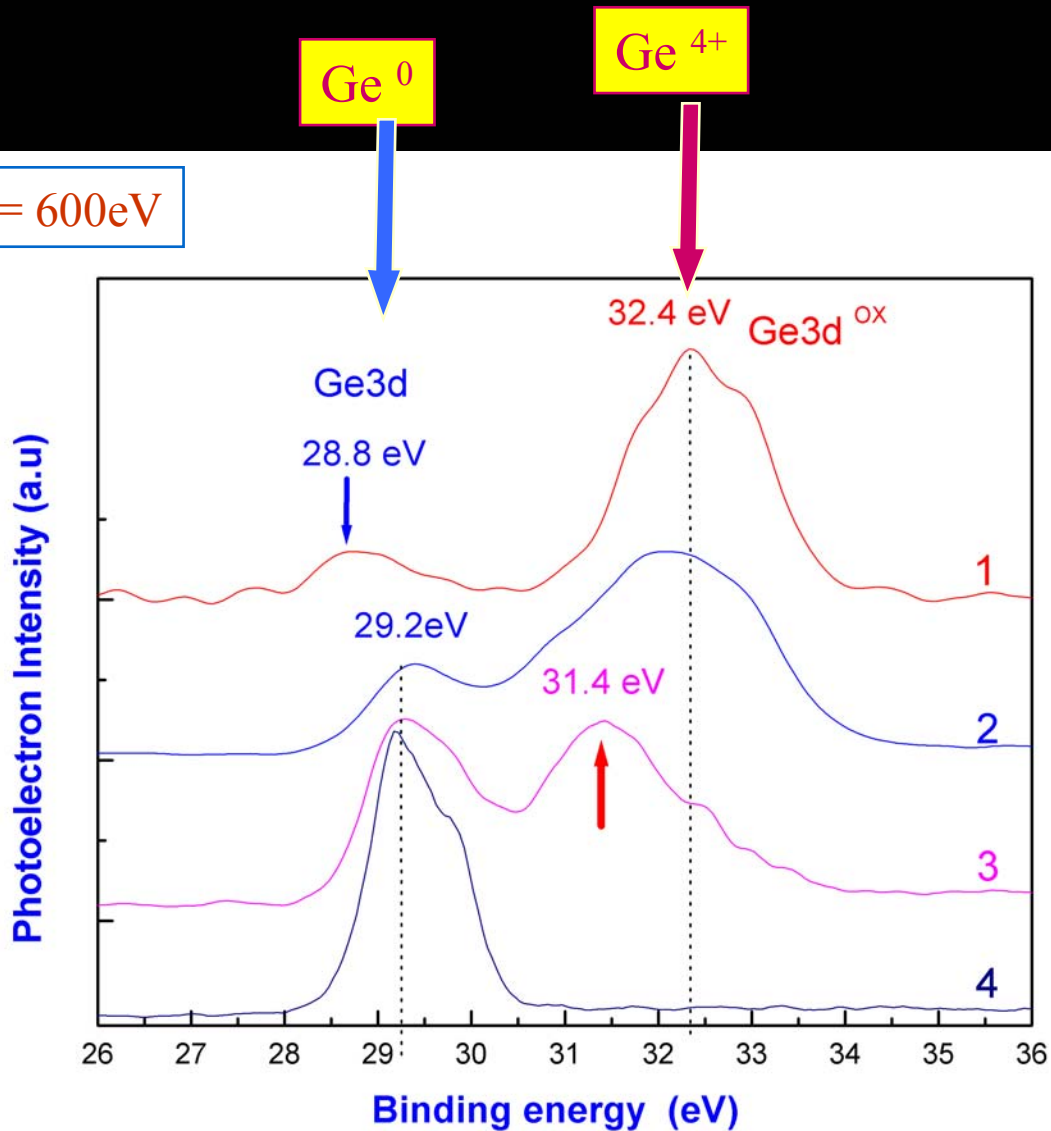
Ge⁰

Ge⁴⁺



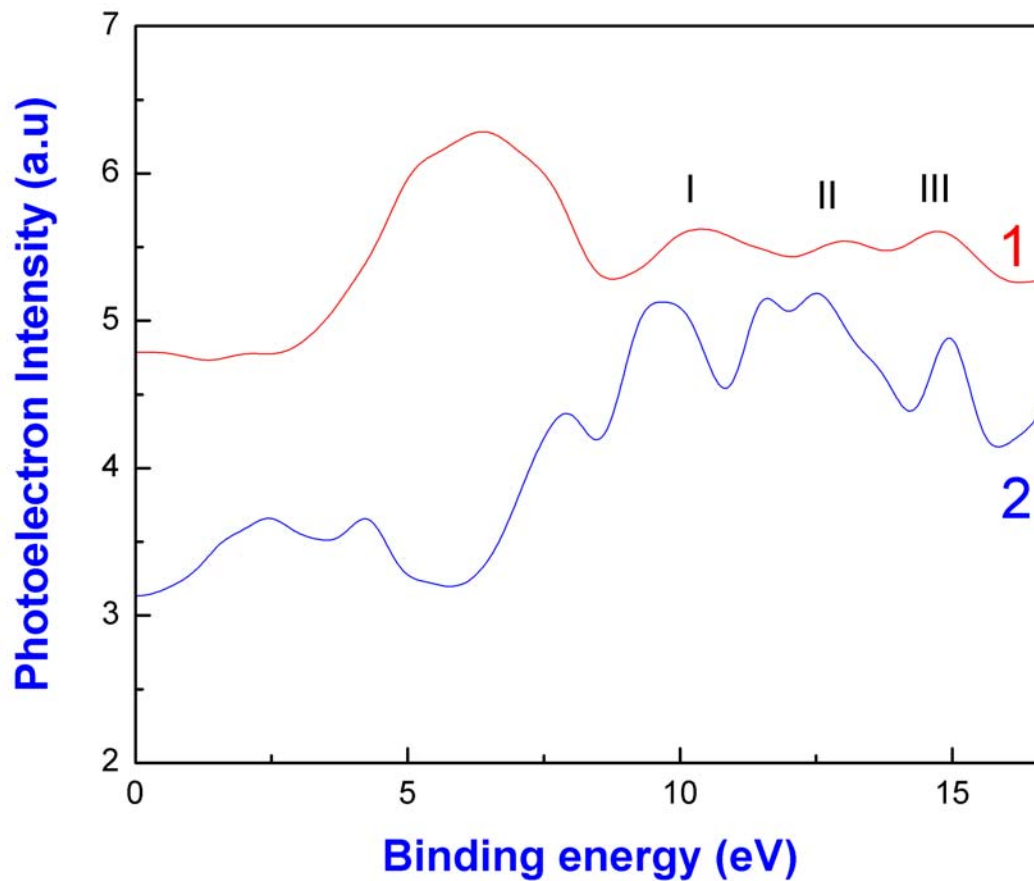
Native oxide on CP4 etched surface

$h\nu = 600\text{eV}$



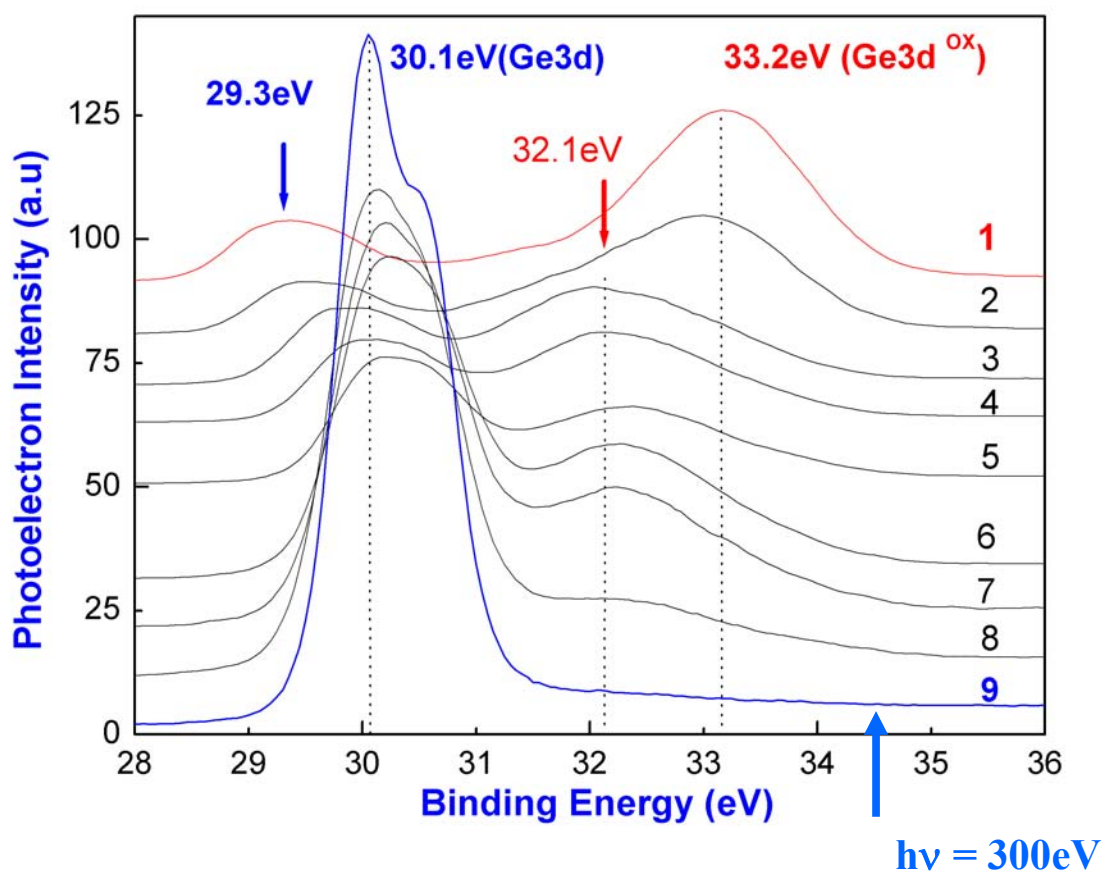
1. Native oxide
2. After Ar Sputtering, 1keV Ar^+ , $P_{\text{Ar}}=10^{-5}\text{mbar}$, 50min.
3. 100min.
4. 1.5keV, 60min.

Valence Band



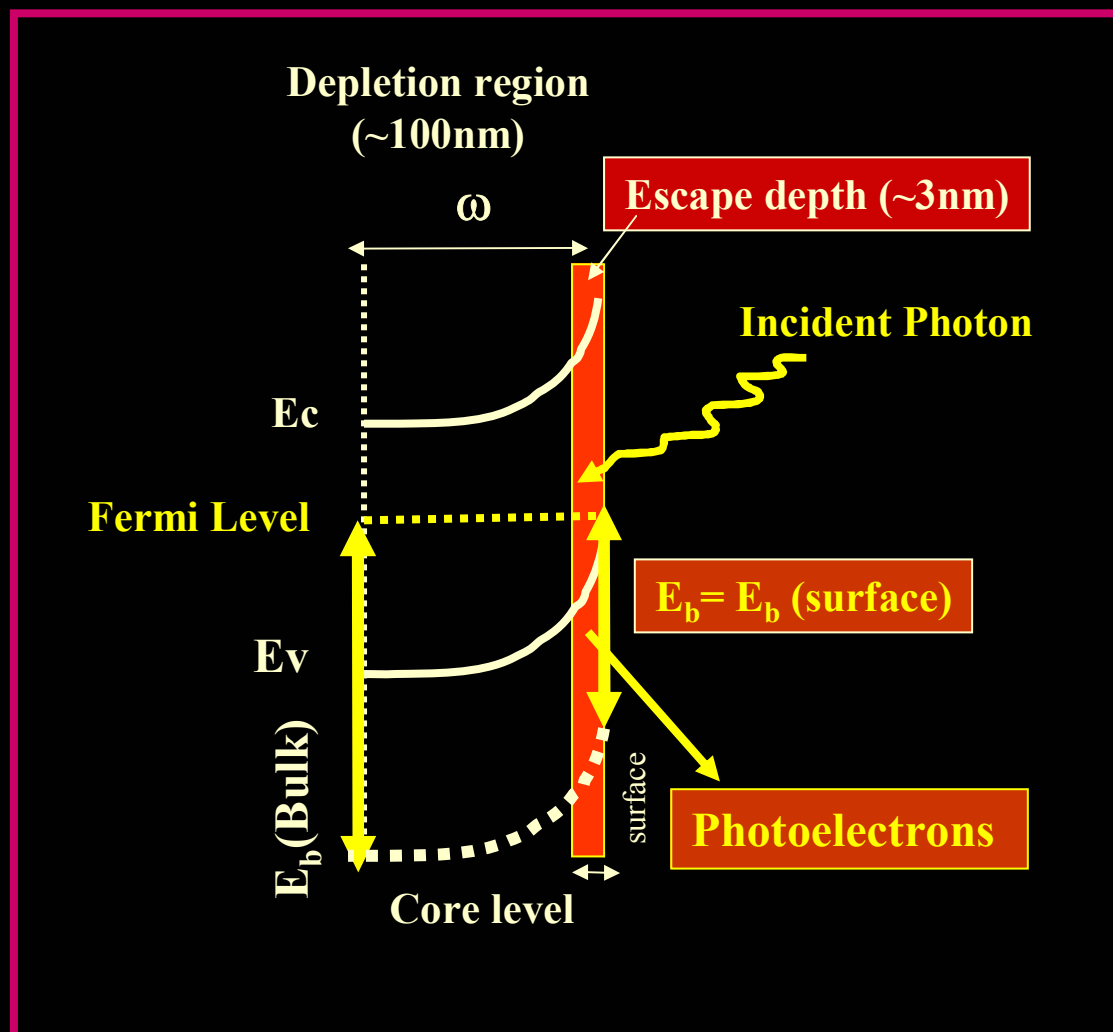
1. Native oxide
2. After Ar⁺ Sputtering, 1.5keV, P_{Ar}=10⁻⁵mbar, 160min. Then T=315°C, 20min.

Oxidized Ge(011) surface
T= 380°C, t = 25min. PO₂ = 400Torr



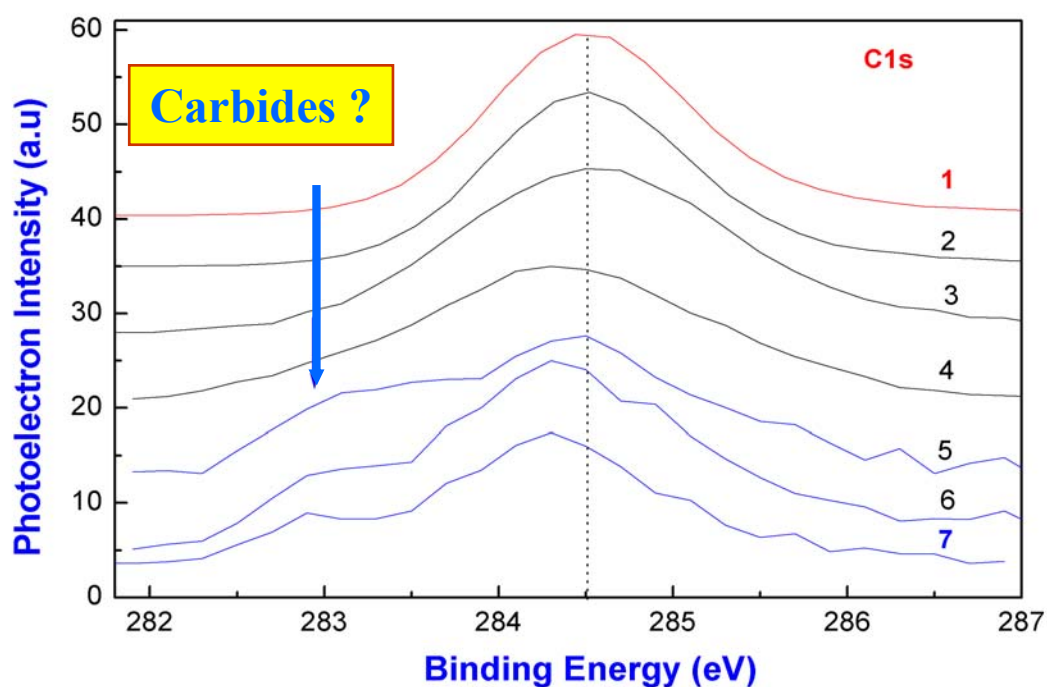
- 1:** As oxidized surface
- 2-8:** After successive Ar⁺ Sputtering cycles, hν= 650eV.
- 9:** hν= 300eV

Surface Depletion Region and Core Level Energies



Oxidized Ge(011) surface

T= 380°C, t = 25min. PO₂ = 400Torr



1: As oxidized surface

2-8: After successive Ar⁺ Sputtering cycles, $h\nu = 650\text{eV}$.

Conclusion

- 1. High density of Surface States at Ge/GeO₂ interface and band bending confirmed**
- 2. Lower oxidation state of Ge observed under sputtering.**
- 3. Carbides-like XPS signal at the Ge/oxide interface to be investigated**

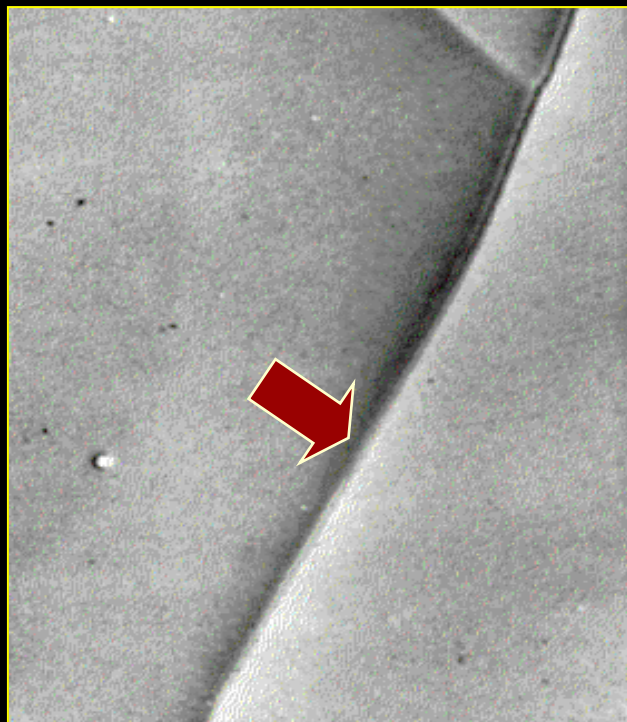
Thank you

Study #2

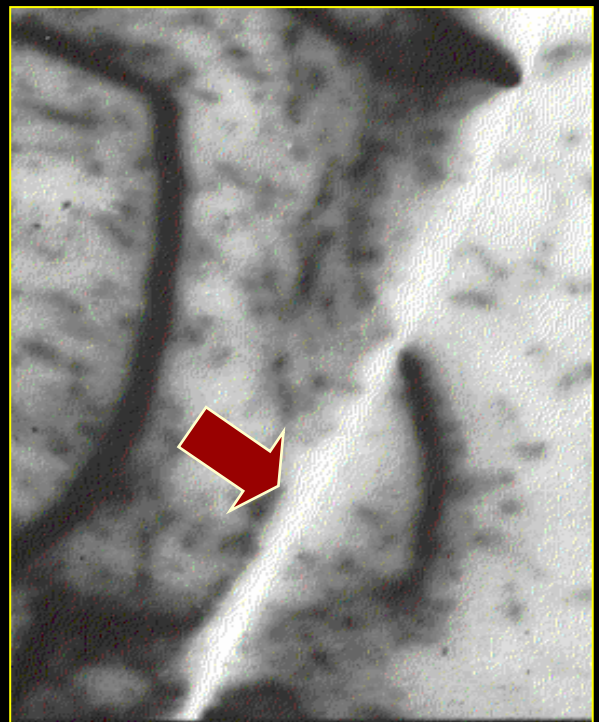
Dopant Segregation at Germanium Surface

EBIC/Grain Boundary

SEM

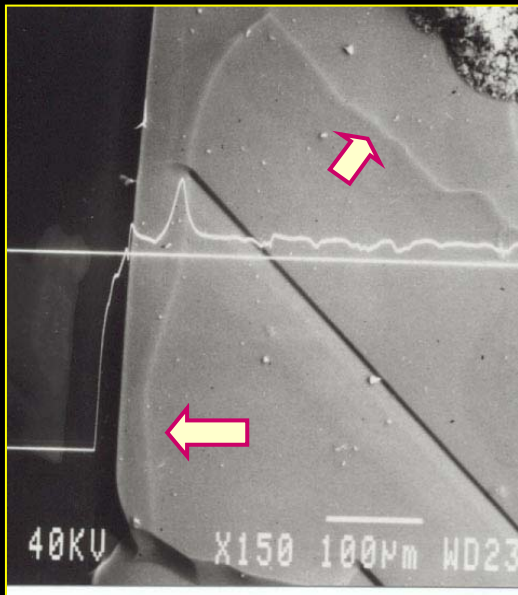


EBIC



EBIC/Grain Boundary

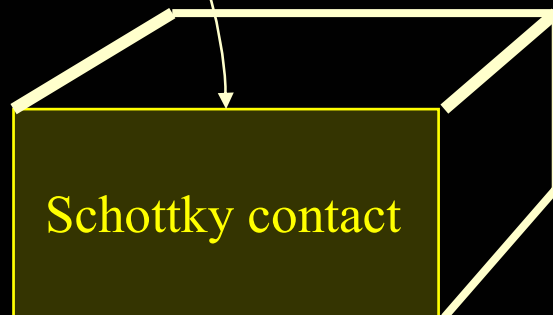
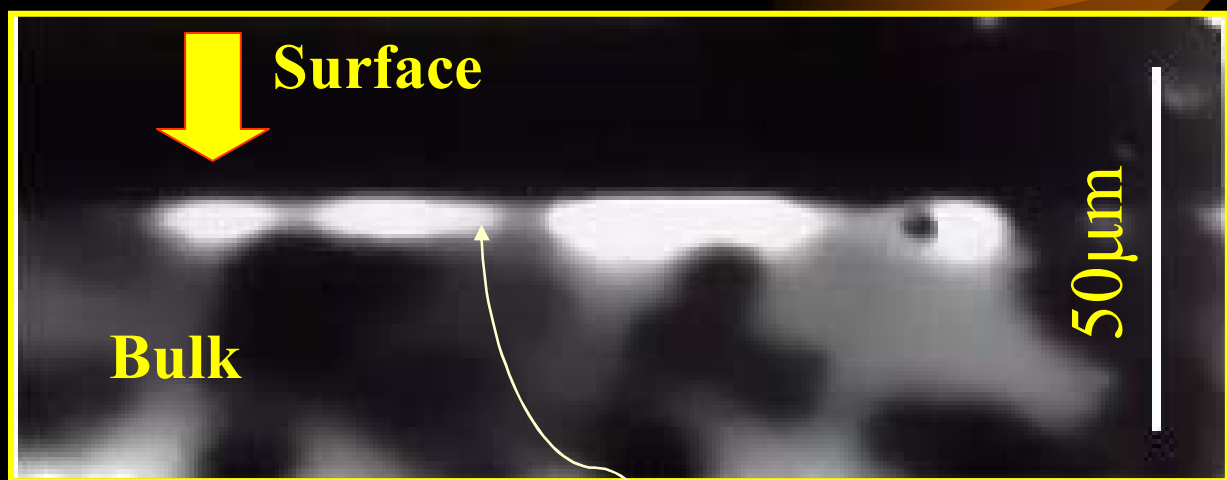
SEM



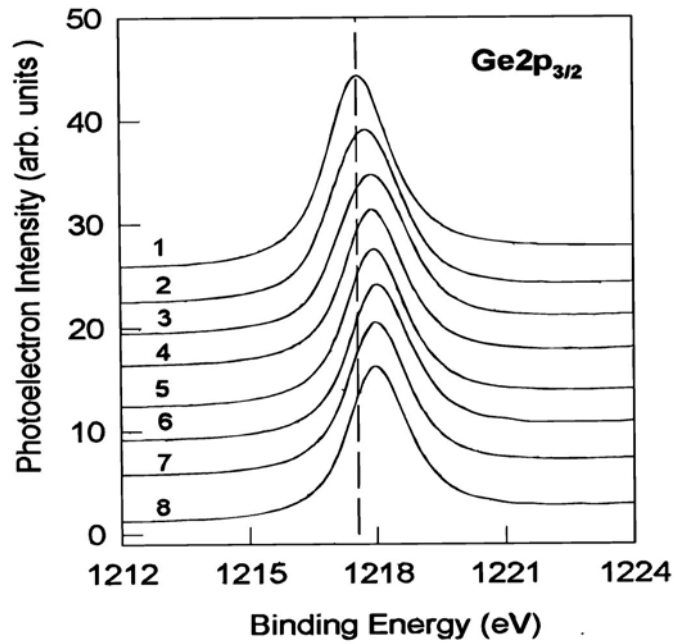
EBIC



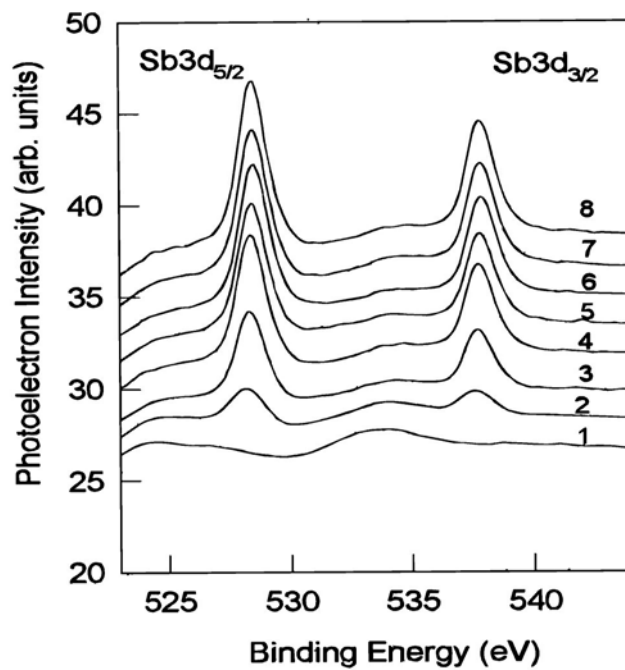
EBIC image of Dopant segregation



Ar etched surface

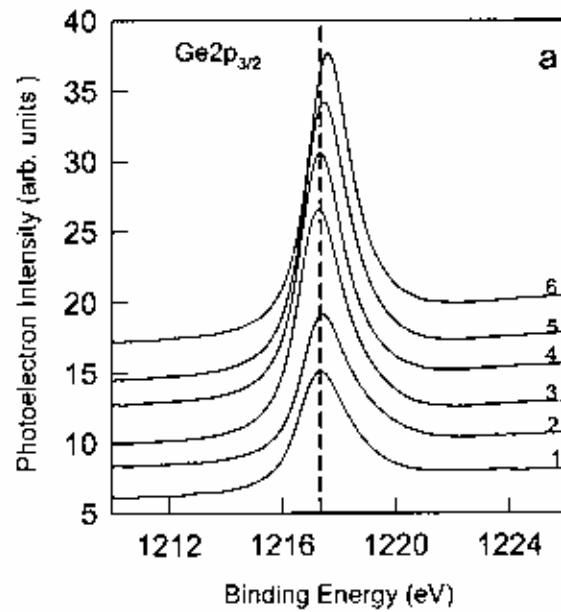


Ge $2p_{3/2}$

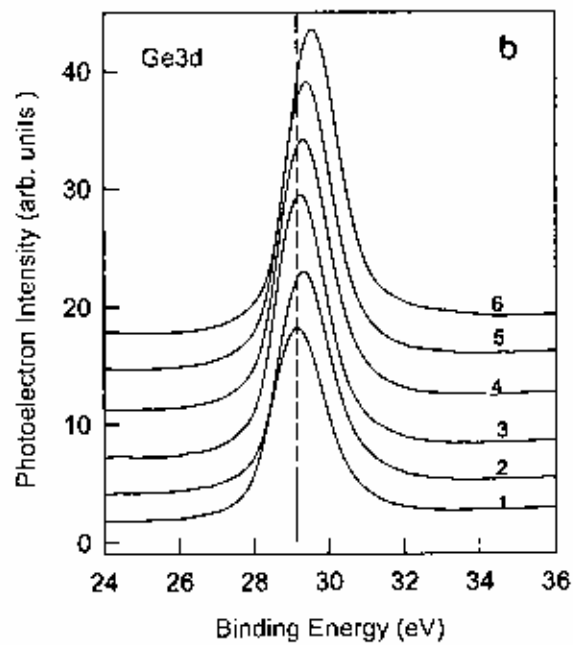
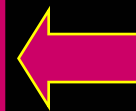


Sb

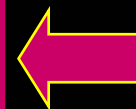
CP4 etched Ge surface



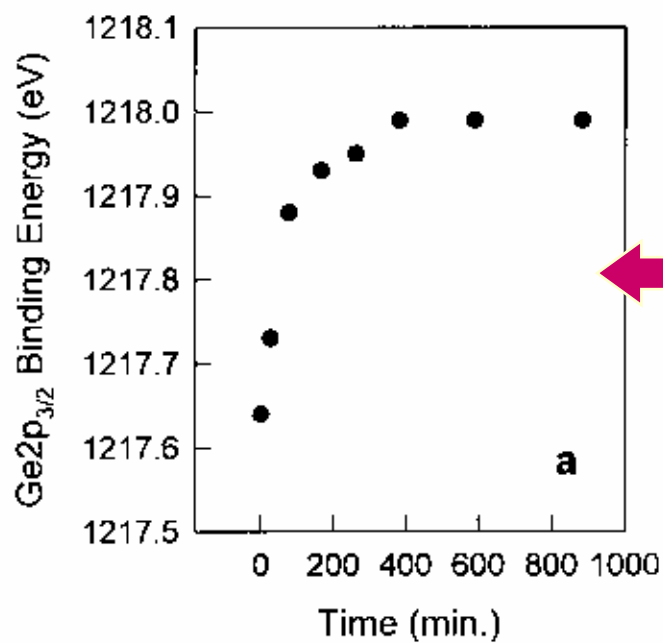
Ge2p_{3/2}



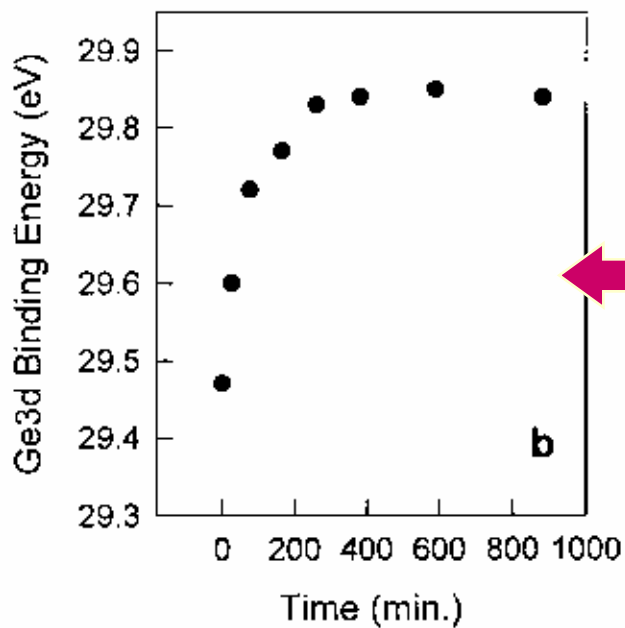
Ge3d



Binding Energy

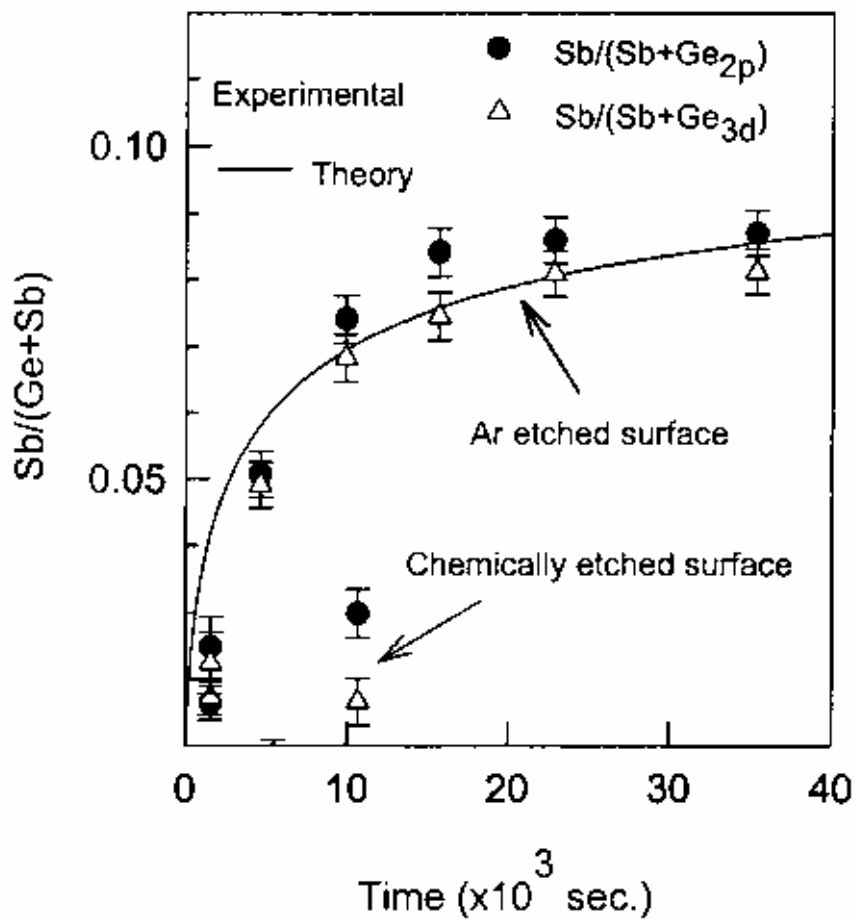


Ge_{2p_{3/2}}

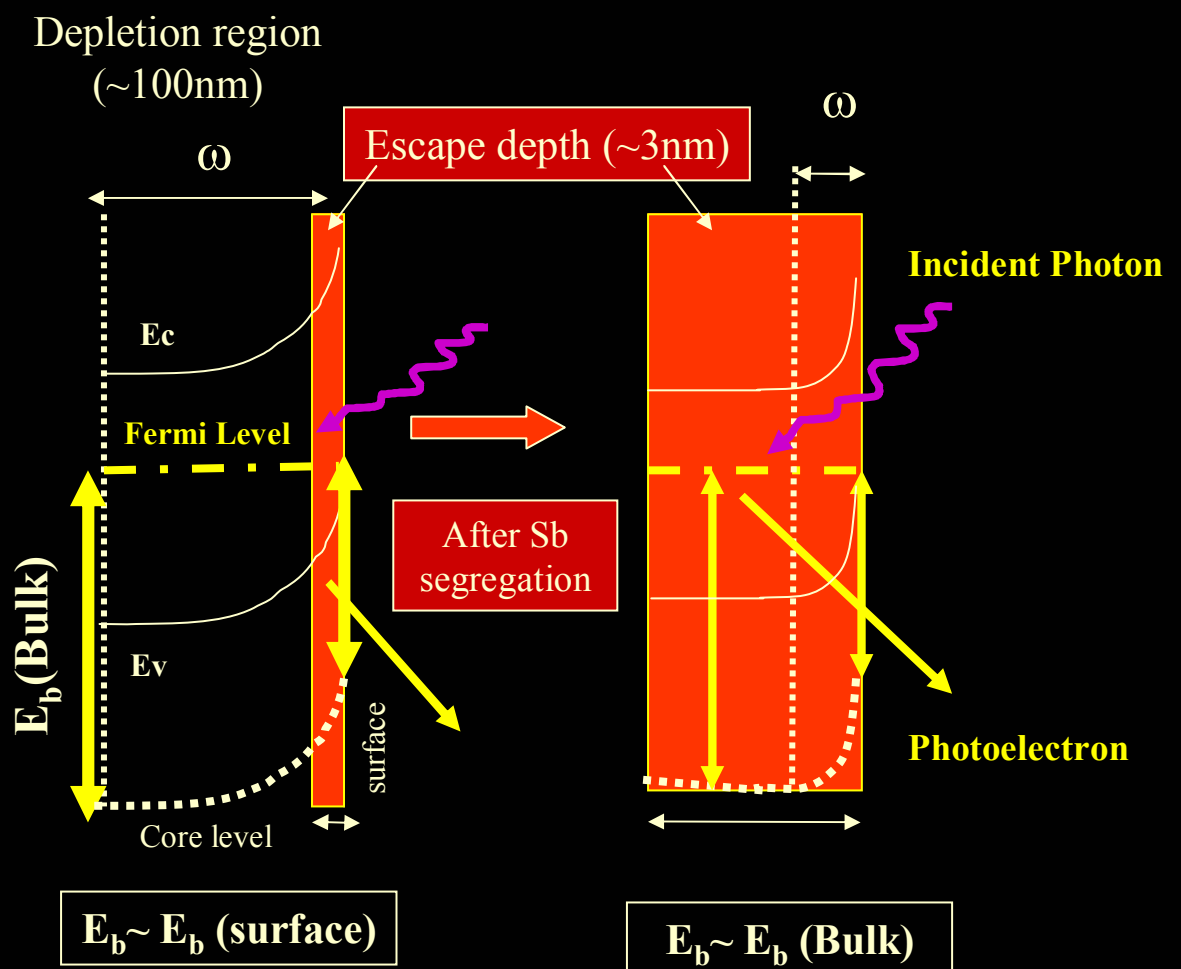


Ge_{3d}

Segregation kinetics



Surface Depletion Region and Core Level Energies



$$\omega = N_d^{-1/2}$$